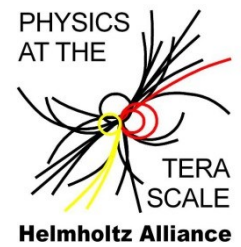
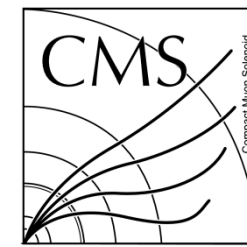




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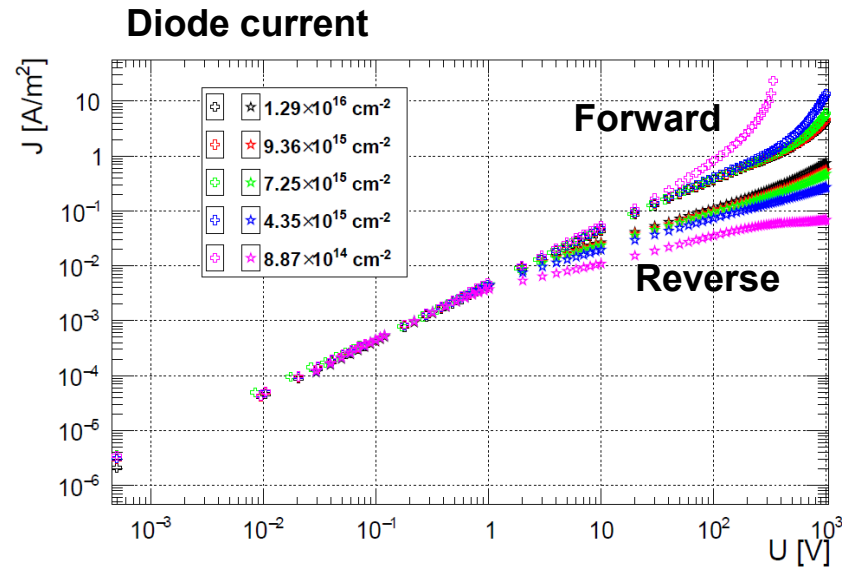
CHRISTIAN SCHARF

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# FORWARD AND REVERSE CURRENT OF HIGHLY IRRADIATED SILICON PAD DIODES

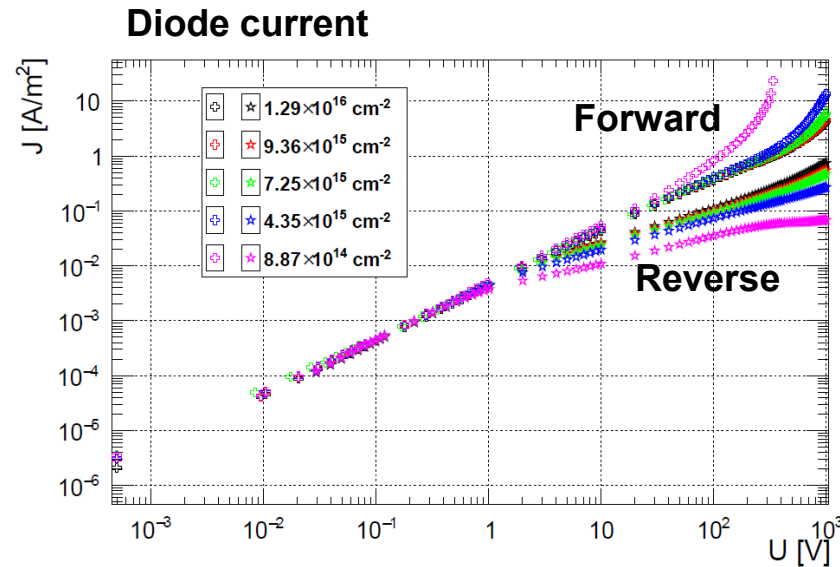


# MOTIVATION



Is the current of highly irradiated silicon diodes understood?

# MOTIVATION



Is the current of highly irradiated silicon diodes understood?

- Goals:
  - Develop models + extract parameters



# SAMPLES

# SAMPLES

## ■ Diodes

- Initial doping  $N_D = 8 \cdot 10^{11} - 5 \cdot 10^{12} \text{ cm}^{-3}$
- N-type and p-type bulk, pad area  $25 \text{ mm}^2$
- Thickness  $200 \text{ }\mu\text{m}$  and  $285 \text{ }\mu\text{m}$

## ■ Irradiations

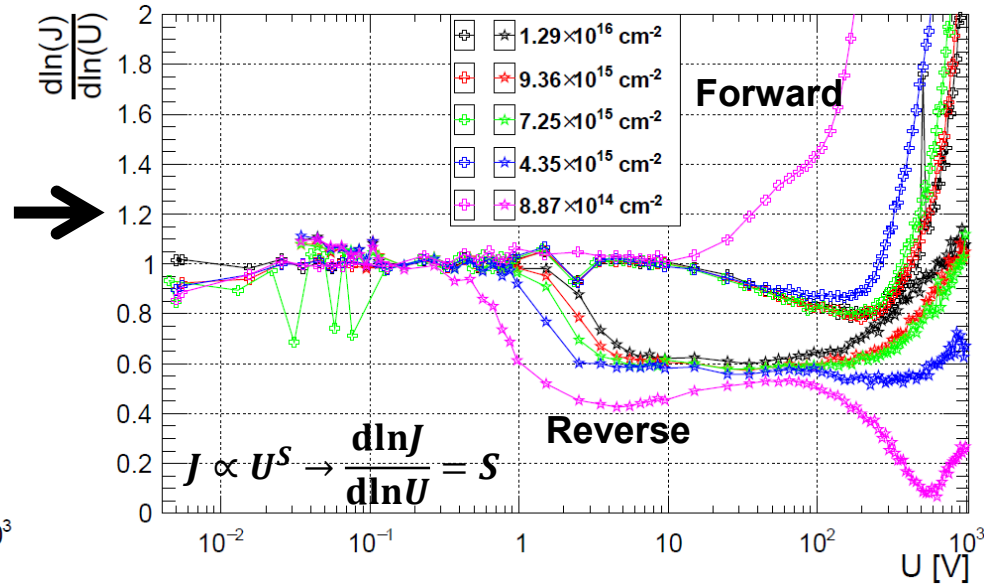
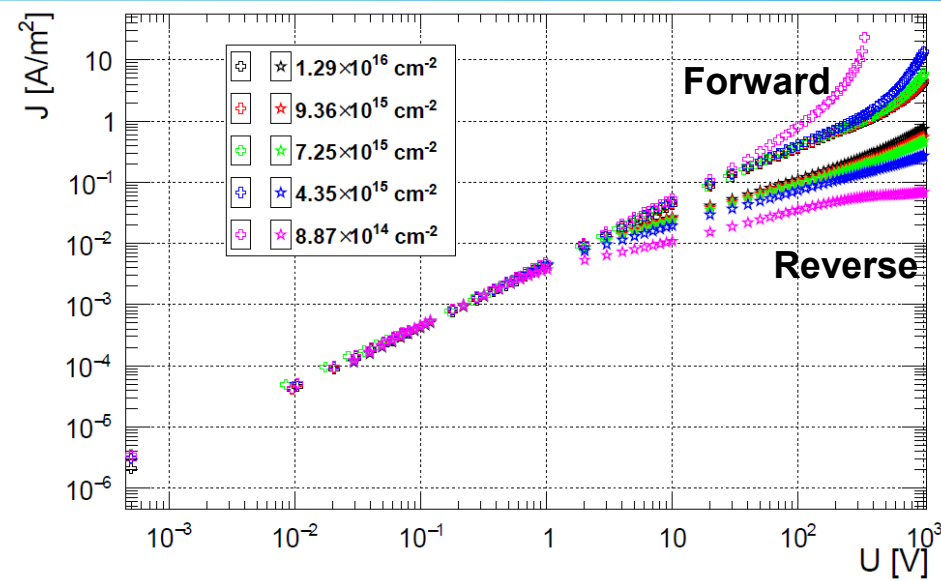
- 24 GeV/c protons to  $\Phi_{eq} = 9 \cdot 10^{14} - 1.3 \cdot 10^{16} \text{ cm}^{-2}$
- No annealing studies so far

- All measurements performed at 243 K

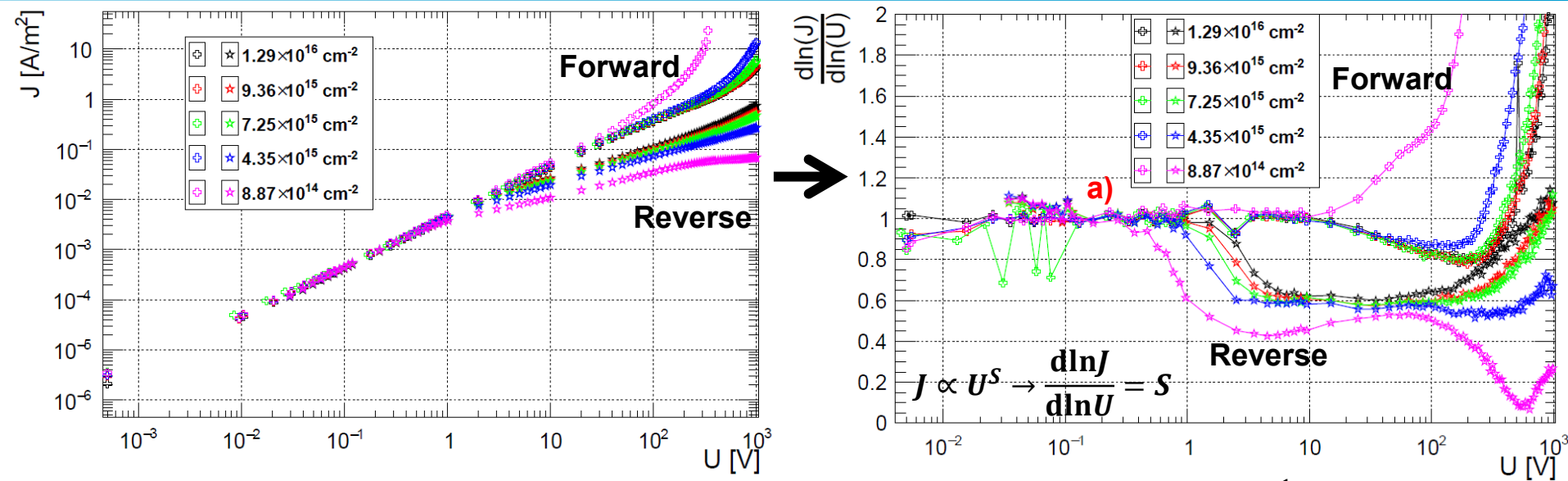


# RESULTS

# CURRENT OF HIGHLY IRRADIATED DIODES



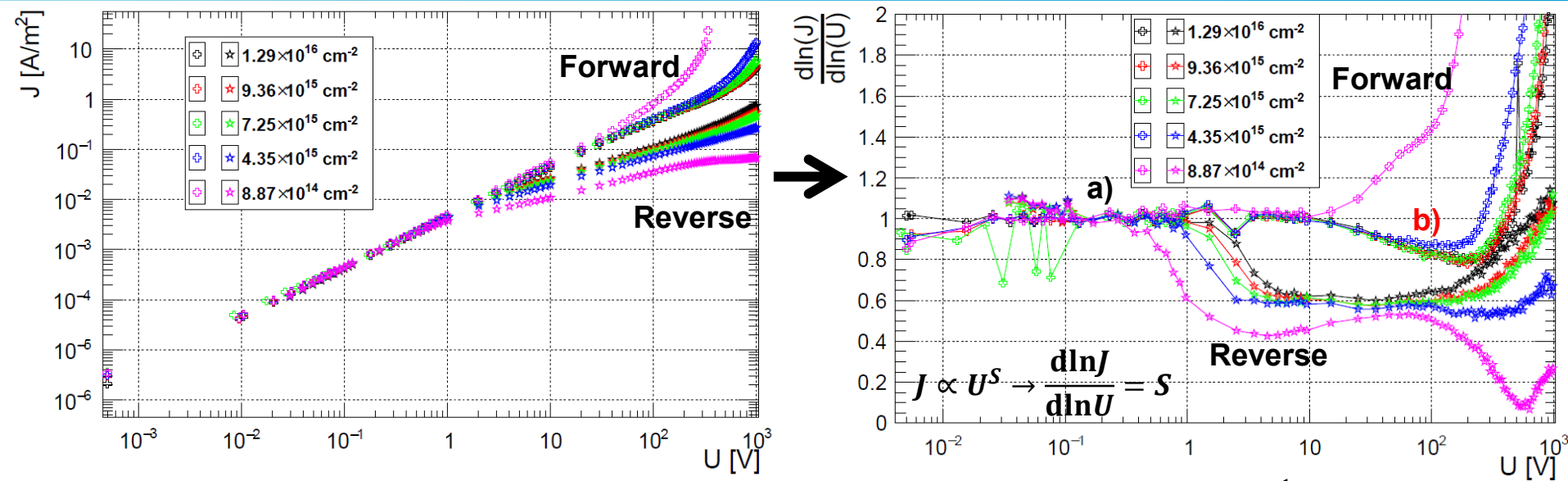
# CURRENT OF HIGHLY IRRADIATED DIODES



a) Forward & reverse: Resistor:  $I = U/R, \rho = (e(n\mu_e + p\mu_h))^{-1}$



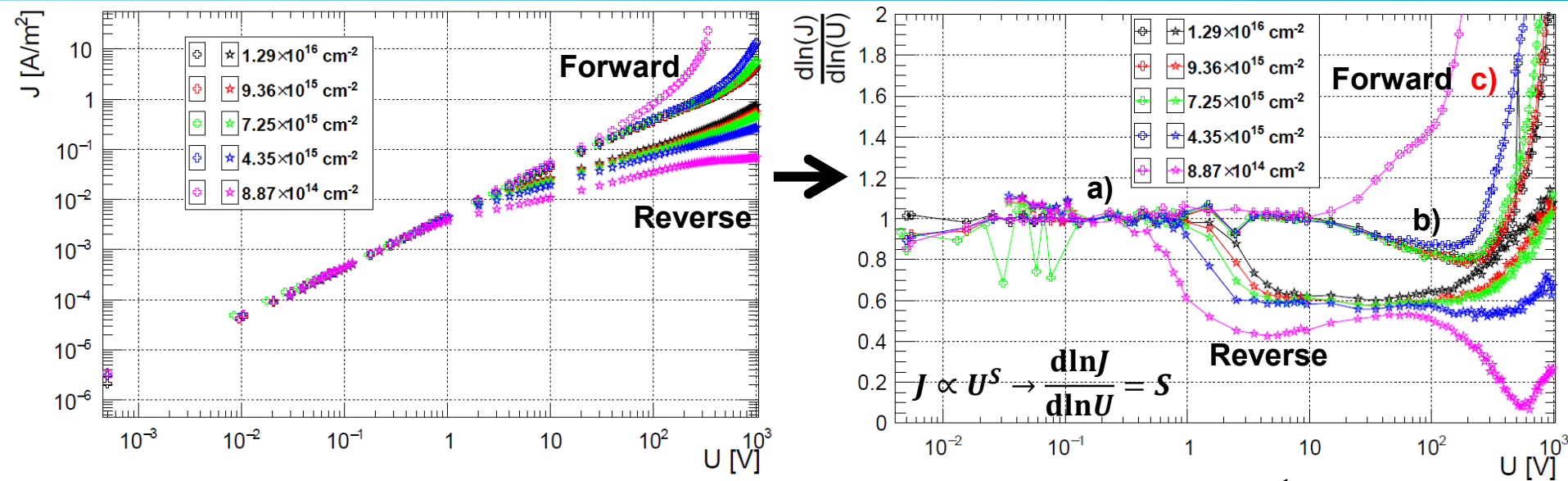
# CURRENT OF HIGHLY IRRADIATED DIODES



**a)** Forward & reverse: Resistor:  $I = U/R, \rho = (e(n\mu_e + p\mu_h))^{-1}$

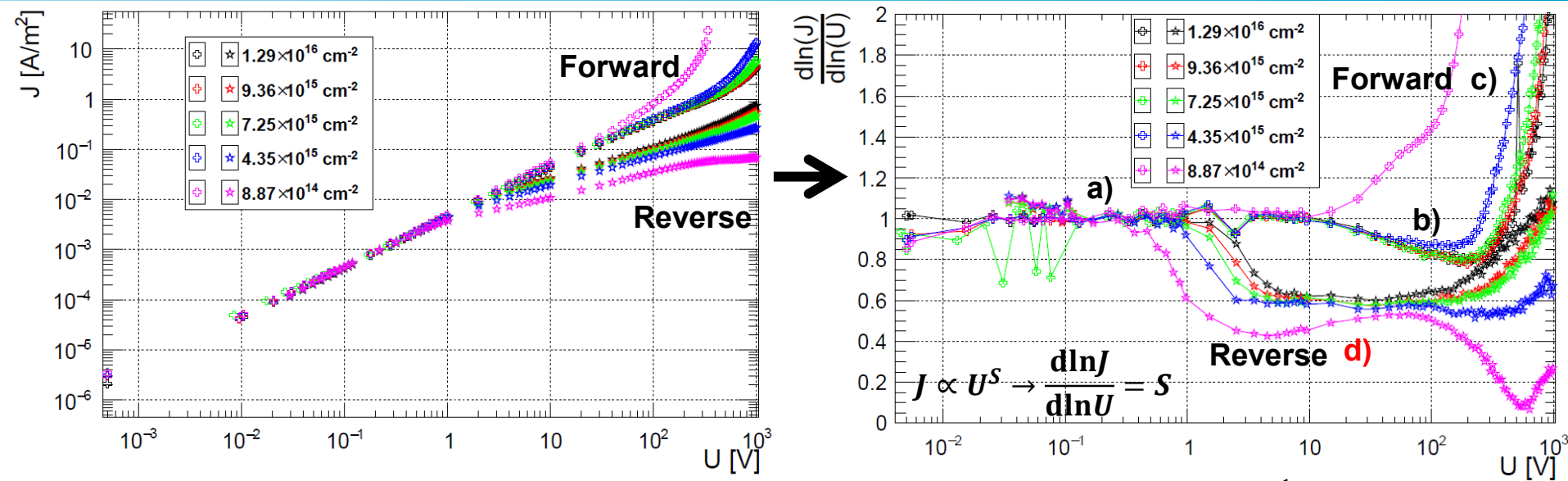
**b)** Forward: Resistor:  $\mu_{e,h}^0 \rightarrow \mu_{e,h}(E)$

# CURRENT OF HIGHLY IRRADIATED DIODES



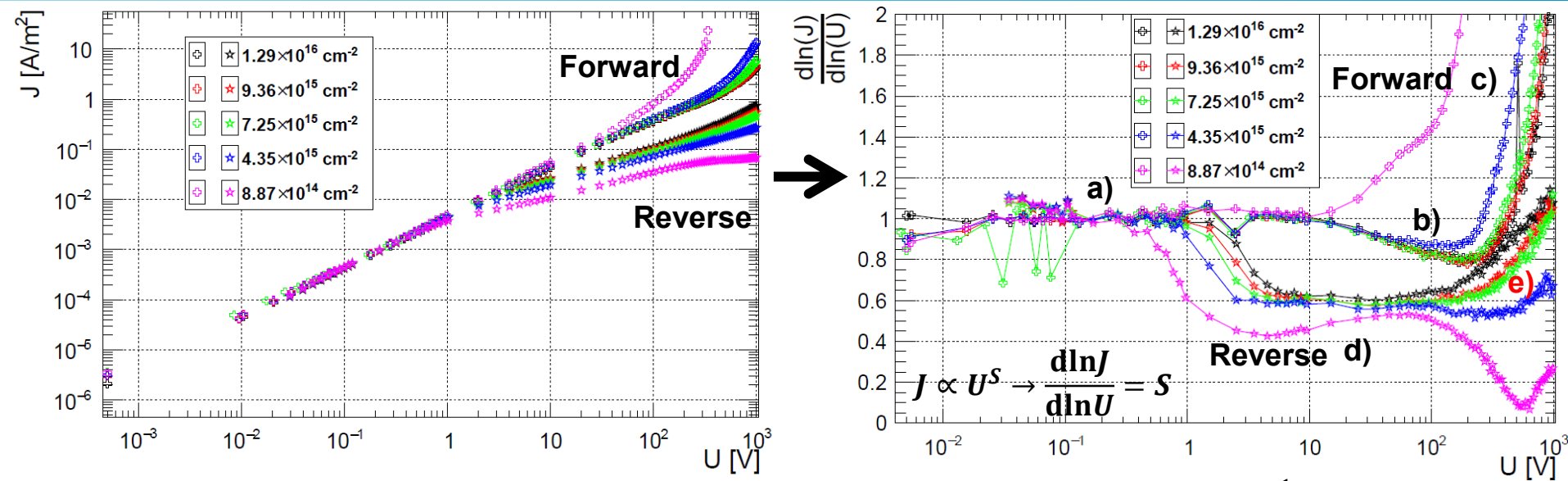
- a) Forward & reverse: Resistor:  $I = U/R, \rho = (e(n\mu_e + p\mu_h))^{-1}$
- b) Forward: Resistor:  $\mu_{e,h}^0 \rightarrow \mu_{e,h}(E)$
- c) Forward: Electron injection  $\rightarrow$  Space-charge-limited currents

# CURRENT OF HIGHLY IRRADIATED DIODES



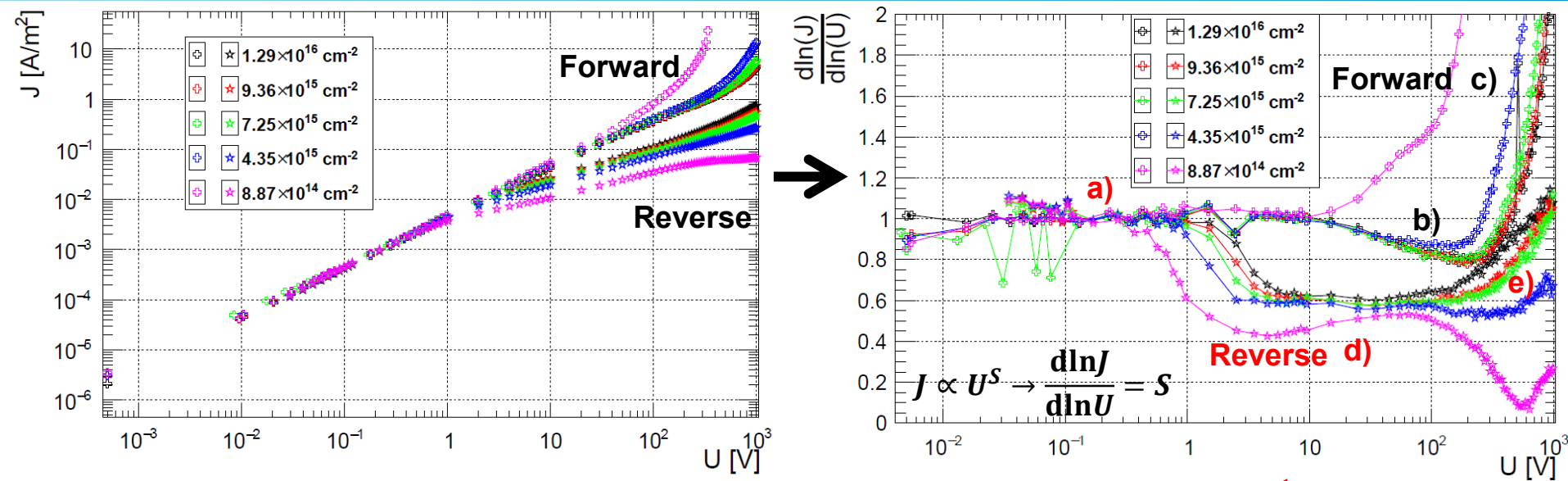
- a) Forward & reverse: Resistor:  $I = U/R, \rho = (e(n\mu_e + p\mu_h))^{-1}$
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- d) Reverse: Space charge region SCR + bulk resistance

# CURRENT OF HIGHLY IRRADIATED DIODES



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# CURRENT OF HIGHLY IRRADIATED DIODES



a) Forward & reverse: Resistor:  $I = U/R, \rho = (e(n\mu_e + p\mu_h))^{-1}$

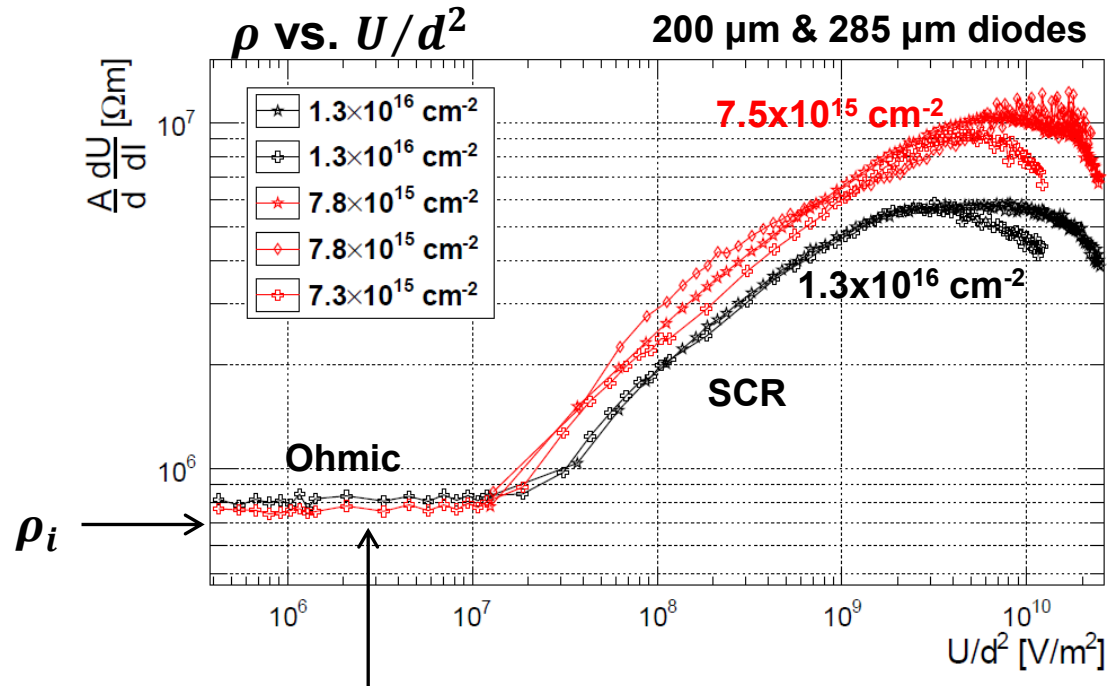
b) Forward: Resistor:  $\mu_{e,h}^0 \rightarrow \mu_{e,h}(E)$

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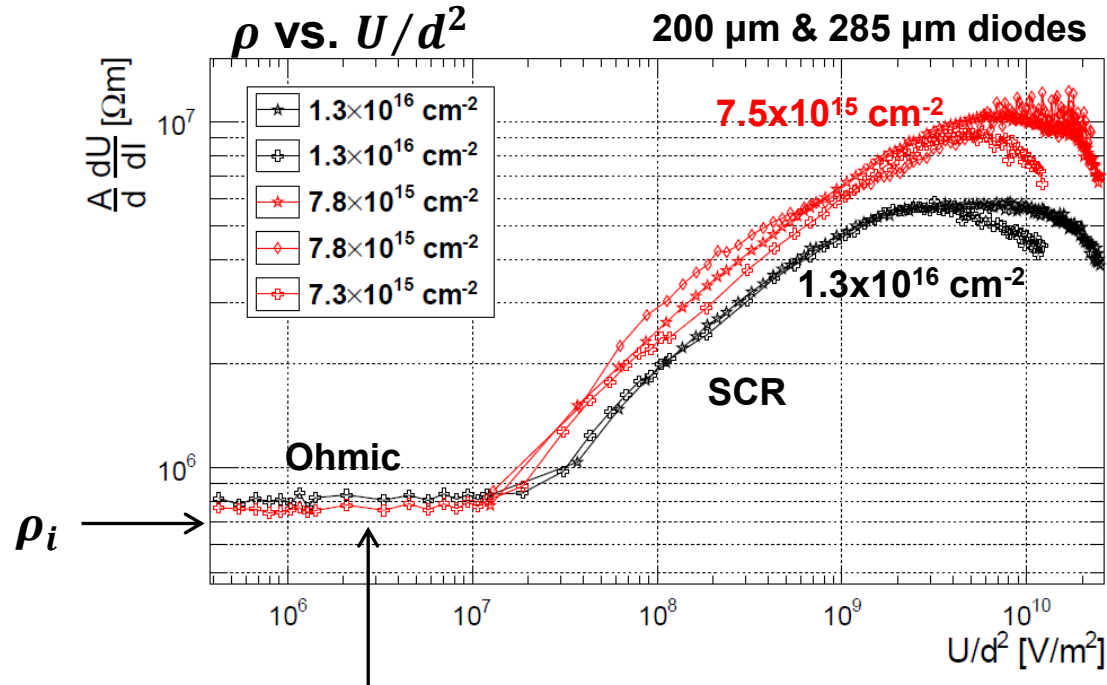
# REVERSE CURRENT OHMIC REGION – NEUTRAL BULK



- High near-intrinsic  $\rho_{ohm} \approx \rho_i$  at small bias voltages

$$\rho(\phi_{eq}) = \left( en_i(\mu_e(\phi_{eq}) + \mu_h(\phi_{eq})) \right)^{-1}$$

# REVERSE CURRENT OHMIC REGION – NEUTRAL BULK



- High near-intrinsic  $\rho_{ohm} \approx \rho_i$  at small bias voltages

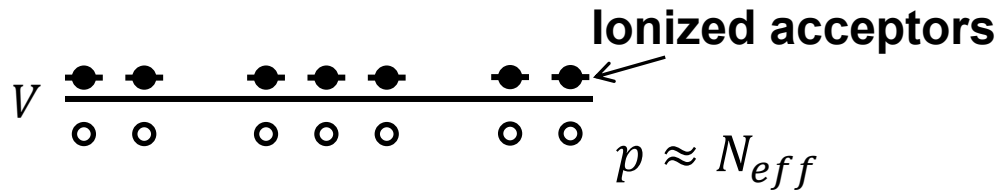
$$\rho(\phi_{eq}) = \left( en_i (\mu_e(\phi_{eq}) + \mu_h(\phi_{eq})) \right)^{-1}$$

$$\rightarrow \text{Extract } (\mu_e + \mu_h)(\phi_{eq})$$

# REVERSE CURRENT OHMIC REGION – NEUTRAL BULK

Non-irradiated

$C$   $\overline{\hspace{10em}}$   $n \ll p$

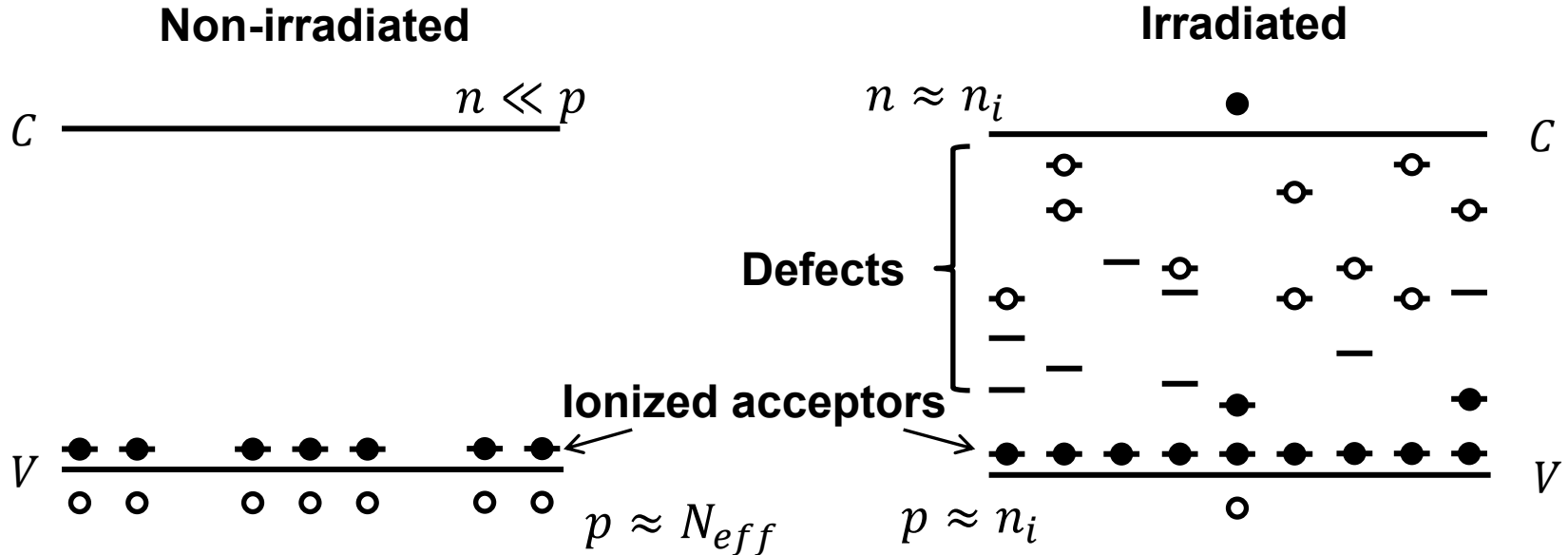


$$\rho = (e(n\mu_e + p\mu_h))^{-1}$$



# REVERSE CURRENT

## OHMIC REGION – NEUTRAL BULK



### Carrier removal

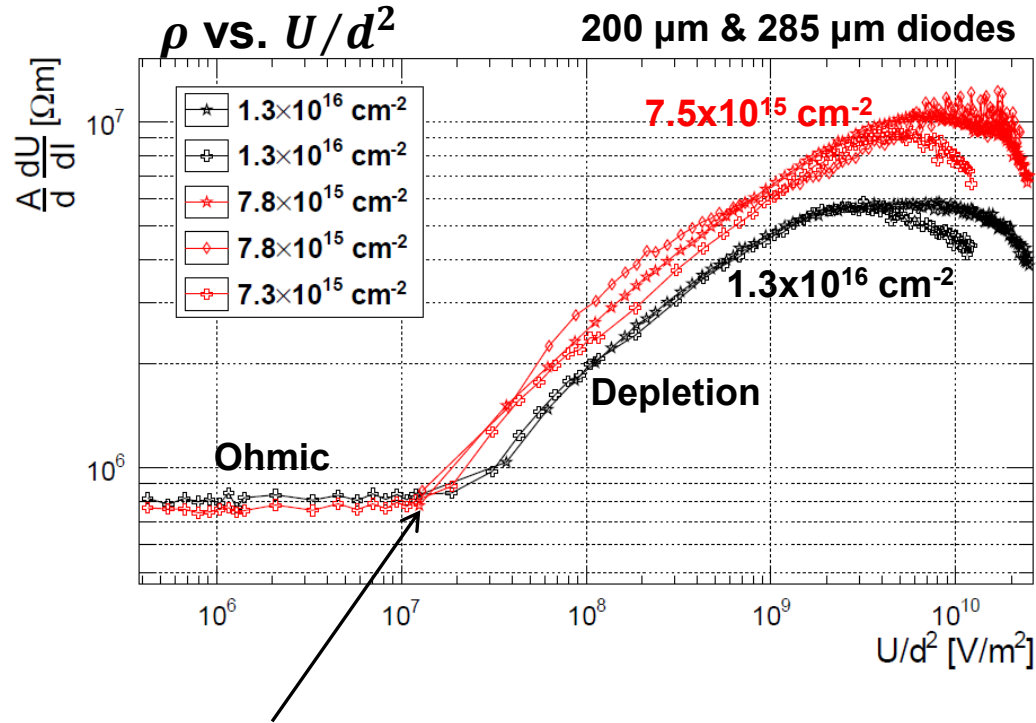
→ W.M. Bullis. *Solid-State Electronics*. 9(2):143-168, 1966.  
 → Z. Li. *NIMA*. 342(1):105-118, 1994.

- Free carriers trapped at deep defects

- $n \approx p \approx n_i$

$$\rho = (e(n\mu_e + p\mu_h))^{-1}$$

# REVERSE CURRENT SPACE-CHARGE REGION




- Transition ohmic current to SCR generation current
  - Common threshold  $U_{th}/d^2$

$$\rho = (e(n\mu_e + p\mu_h))^{-1}$$

# REVERSE CURRENT SPACE-CHARGE REGION

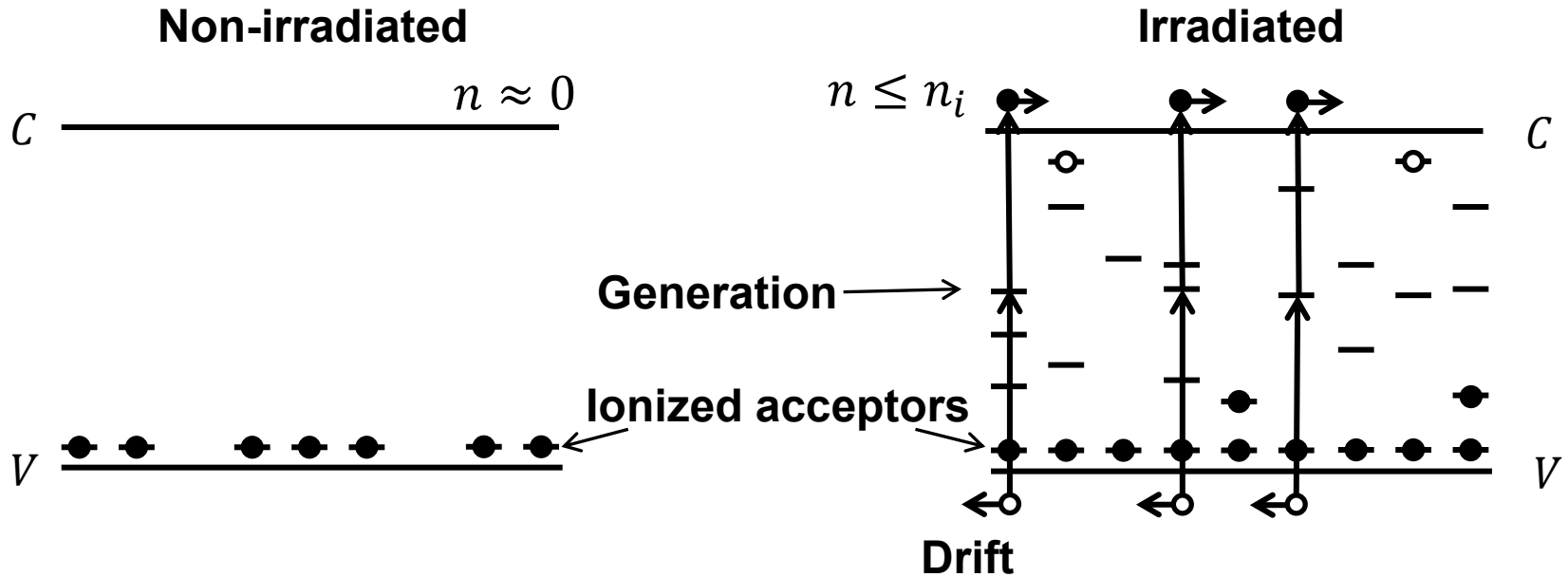
Non-irradiated

C  $n \approx 0$

V  Ionized acceptors

$$\rho = (e(n\mu_e + p\mu_h))^{-1}$$

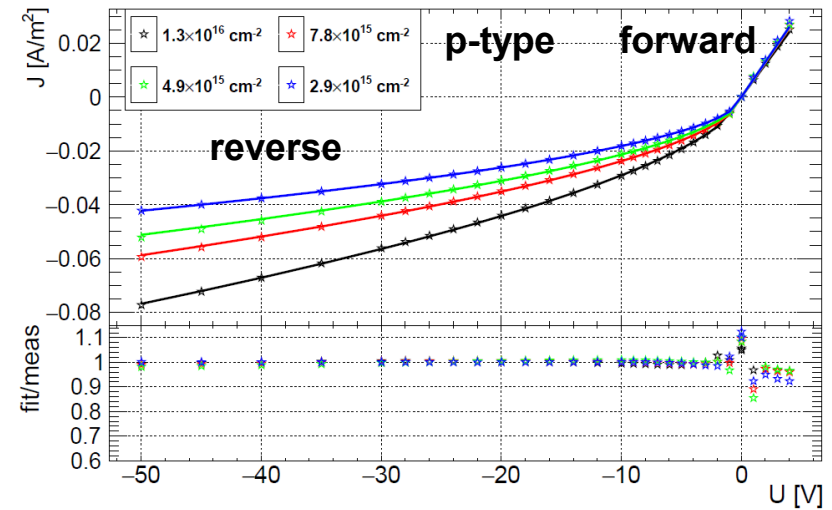
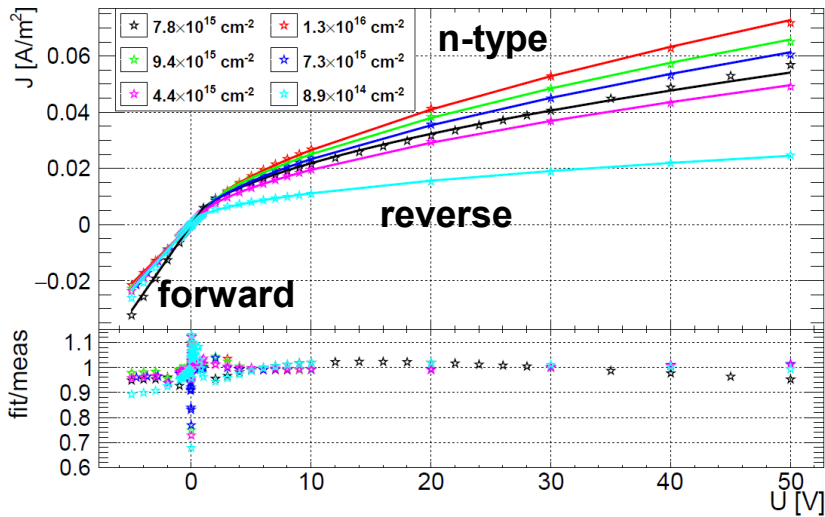
# REVERSE CURRENT SPACE-CHARGE REGION



- Fast generation  $\rightarrow$  High  $n, p$  in the SCR
  - Ohmic when  $n, p \approx n_i$
  - $U_{th}/d^2$  when  $n, p < n_i$  in the SCR due to drift

$$\rho = (e(n\mu_e + p\mu_h))^{-1}$$

# REVERSE CURRENT MODEL MEDIUM BIAS

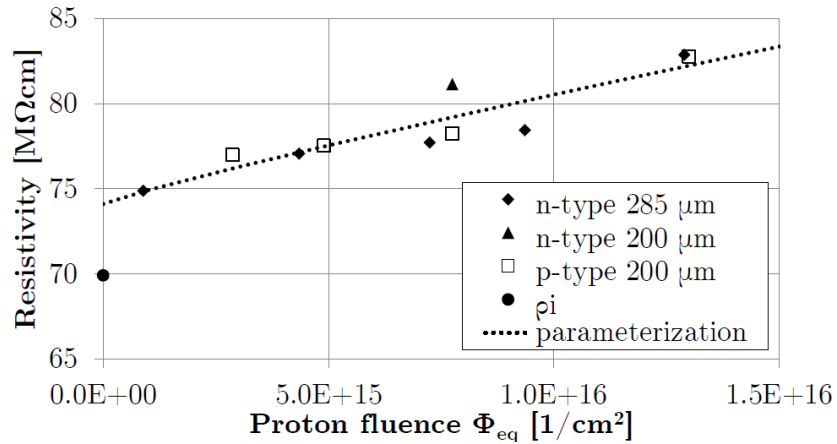


$$R(U) = \begin{cases} \rho_{ohm}(\Phi_{eq}) \cdot \frac{d}{A} & U \leq U_{th} \\ \tilde{R}_{SCR}(\Phi_{eq}, A) \cdot U^{1-S(\Phi_{eq})} & U \geq U_{th} \end{cases} \quad \tilde{R}_{SCR}(\Phi_{eq})^{-1} = \frac{A \left( d^2 \cdot \frac{U_{th}}{d^2}(\Phi_{eq}) \right)^{1-S(\Phi_{eq})}}{d \cdot \rho_{ohm}(\Phi_{eq})}$$

- Simple model with three parameters

- Fit 5 V forward to 50 V reverse describes measurements within few percent

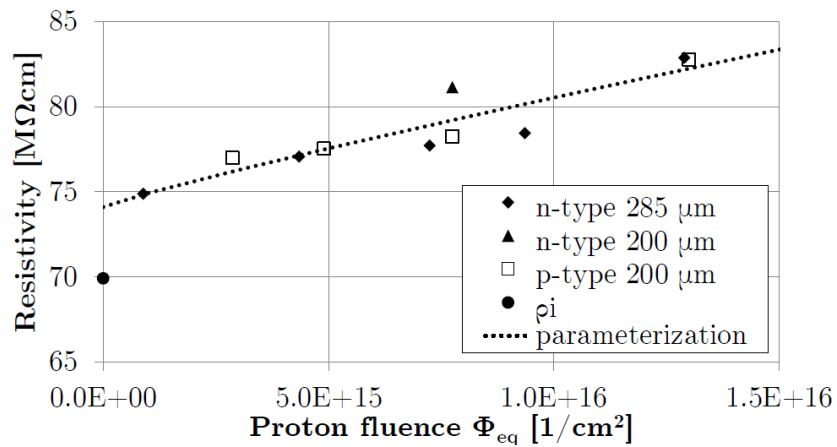
# REVERSE CURRENT MODEL MEDIUM BIAS



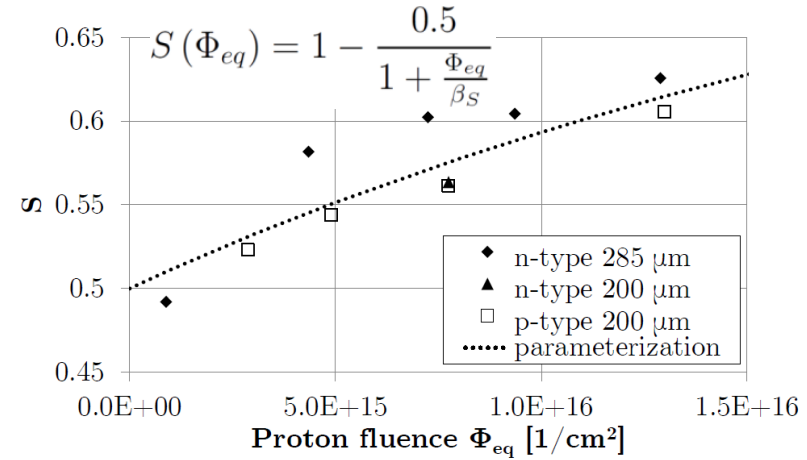
$$\rho_{ohm}(\Phi_{eq}) = 74.1 \text{ M}\Omega\text{cm} \cdot \left( 1 + \left( \frac{\Phi_{eq}}{\beta_{mob}} \right)^{0.9} \right)$$

- Parameters vs. fluence
  - $\rho_{ohm} \rightarrow$  Ionized impurity scattering

# REVERSE CURRENT MODEL MEDIUM BIAS



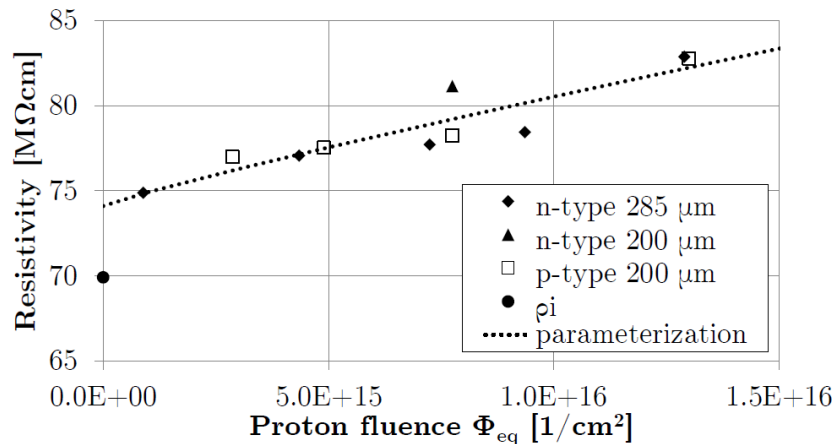
$$\rho_{ohm}(\Phi_{eq}) = 74.1 \text{ M}\Omega\text{cm} \cdot \left( 1 + \left( \frac{\Phi_{eq}}{\beta_{mob}} \right)^{0.9} \right)$$



## ■ Parameters vs. fluence

- $\rho_{ohm} \rightarrow$  Ionized impurity scattering
- $S \rightarrow S(0) = 1/2, S(\Phi_{eq} \rightarrow \infty) \rightarrow 1$

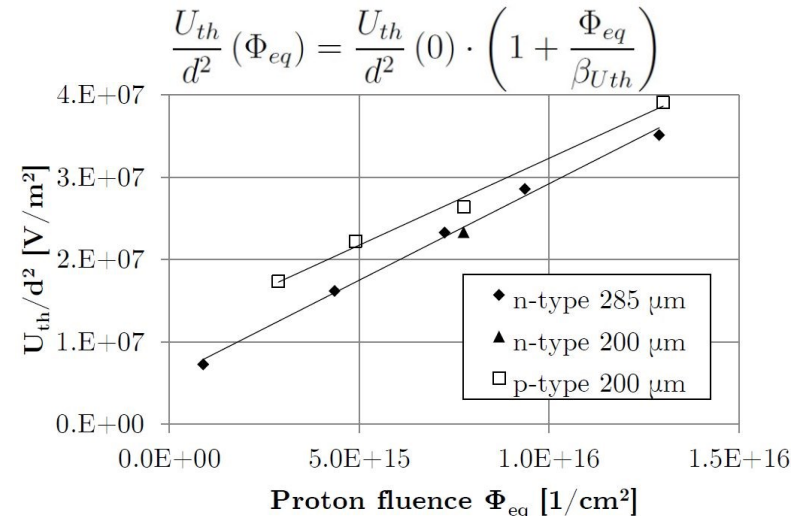
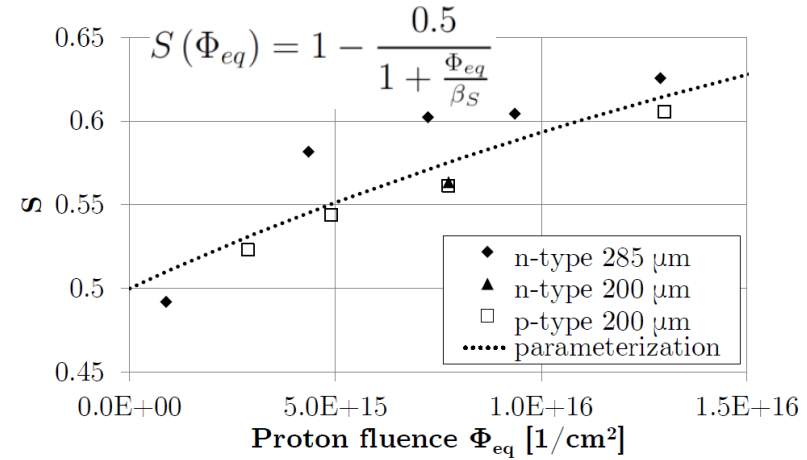
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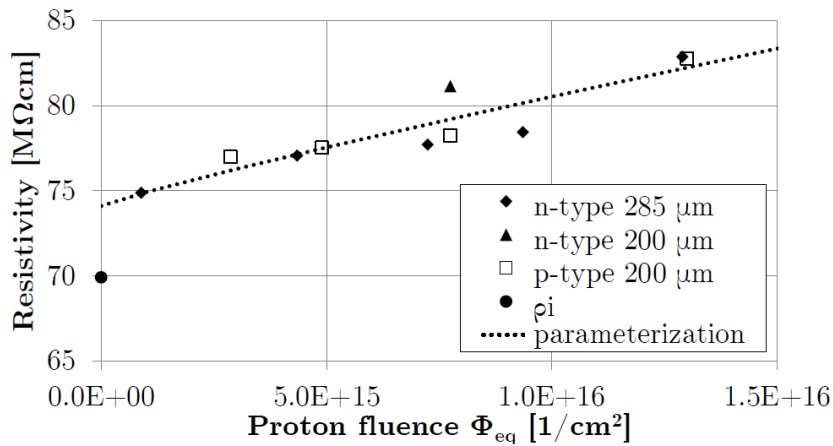
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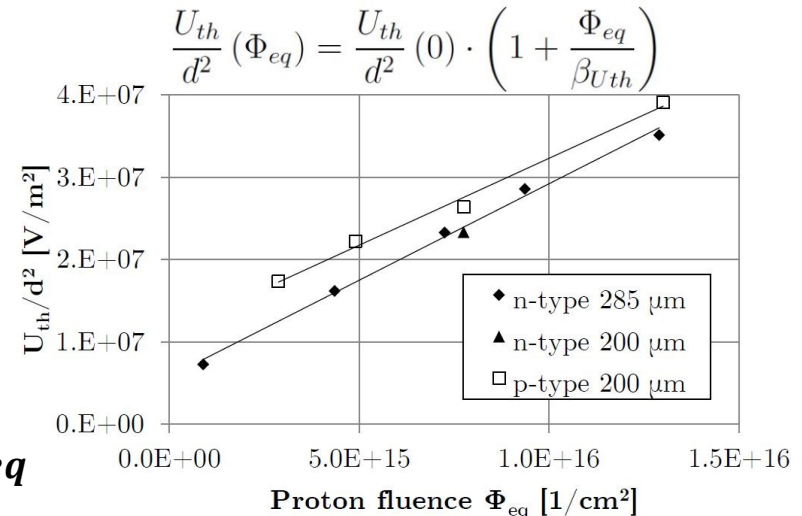
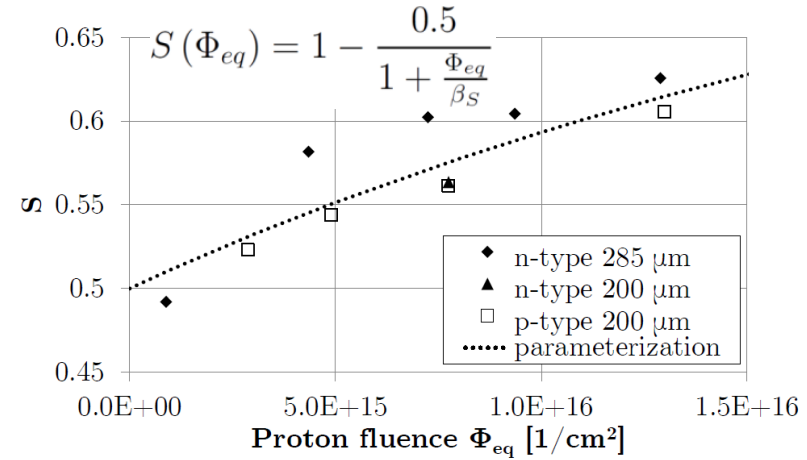
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## Parameters vs. fluence

- $\rho_{ohm} \rightarrow$  Ionized impurity scattering
- $S \rightarrow S(0) = 1/2, S(\phi_{eq} \rightarrow \infty) \rightarrow 1$
- $\frac{U_{th}}{d^2} \rightarrow$  Linear with  $\phi_{eq} \rightarrow$  Measure  $\phi_{eq}$



# REVERSE CURRENT OHMIC REGION – MOBILITY

- Assume ionized impurity scattering dominates at 243 K

$$\mu(N) = \mu_{min} + \frac{\mu_{max} - \mu_{min}}{1 + \left(\frac{N}{N_{ref}}\right)^\zeta} \quad N_{ref} \approx (0.5 - 2.4) \cdot 10^{17} \text{ cm}^{-3}$$

# REVERSE CURRENT OHMIC REGION – MOBILITY

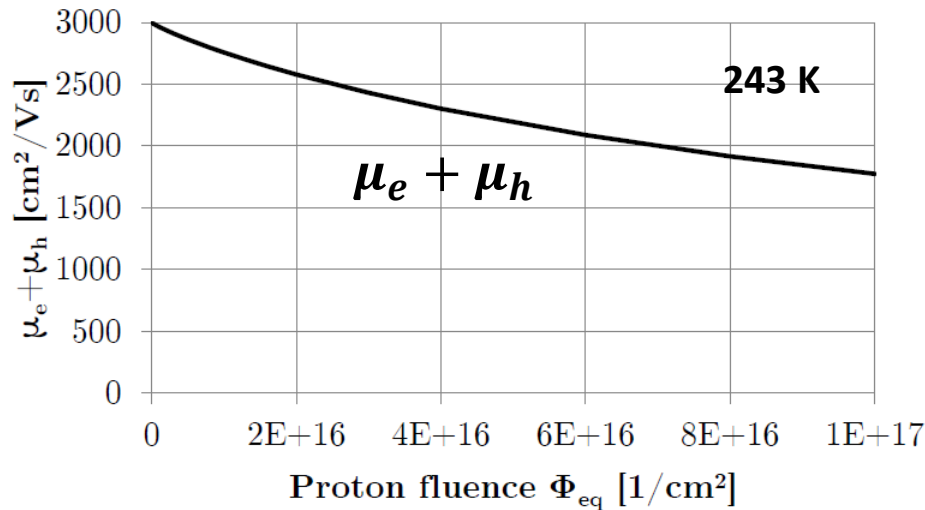
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Neglect  $\mu_{min} \rightarrow \mu_0^e(\Phi_{eq}) + \mu_0^h(\Phi_{eq}) \approx \frac{\mu_0^e + \mu_0^h}{1 + \left(\frac{\Phi_{eq}}{\beta_{mob}}\right)^\zeta}$

# REVERSE CURRENT

## OHMIC REGION – MOBILITY



200  $\mu\text{m}$  & 285  $\mu\text{m}$  diodes  
 $\rho = (en_i(\mu_e + \mu_h))^{-1}$

- Assume ionized impurity scattering dominates at 243 K

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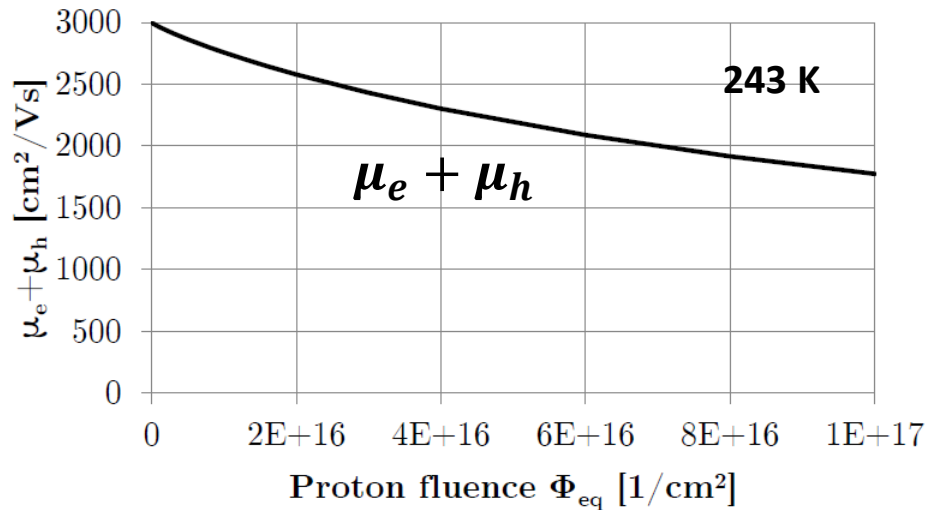
Neglect  $\mu_{min} \rightarrow \mu_0^e(\Phi_{eq}) + \mu_0^h(\Phi_{eq}) \approx \frac{\mu_0^e + \mu_0^h}{1 + \left(\frac{\Phi_{eq}}{\beta_{mob}}\right)^\zeta}$

$$\beta_{mob} = 1.52 \cdot 10^{17} \text{ cm}^{-2}$$

$$\beta_{mob} = N_{ref}/g_{eff}$$

$$g_{eff} \approx 1 \text{ cm}^{-1}$$

# REVERSE CURRENT OHMIC REGION – MOBILITY



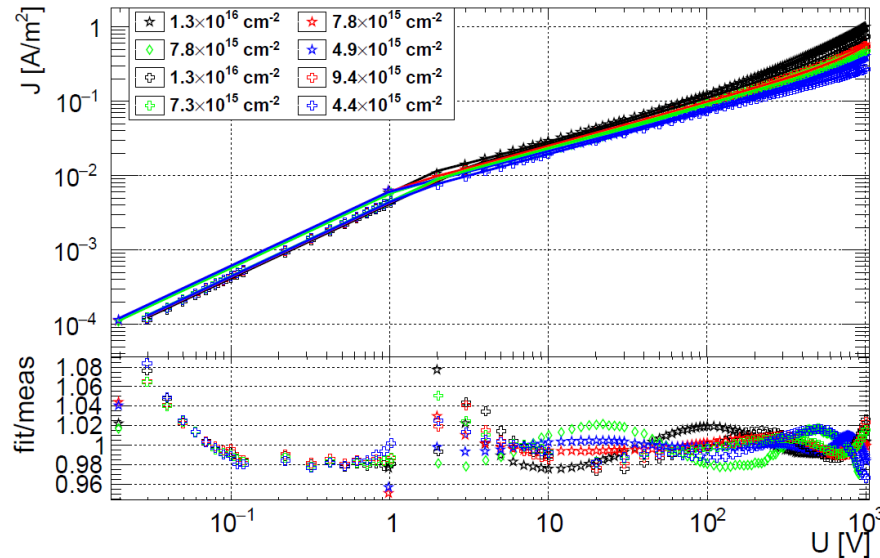
200  $\mu\text{m}$  & 285  $\mu\text{m}$  diodes  
 $\rho = (en_i(\mu_e + \mu_h))^{-1}$

Previous edge-TCT and Hall measurements show much larger decrease of  $(\mu_e + \mu_h)(\phi_{eq})$  up to 50% at  $\phi_{eq} = 10^{16} \text{ cm}^{-2}$  with  $g_{eff} > 10 \text{ cm}^{-1}$

Neglect  $\mu_{min} \rightarrow \mu_0^e(\Phi_{eq}) + \mu_0^h(\Phi_{eq}) \approx \frac{\mu_0^e + \mu_0^h}{1 + \left(\frac{\Phi_{eq}}{\beta_{mob}}\right)^\varsigma}$

$\beta_{mob} = 1.52 \cdot 10^{17} \text{ cm}^{-2}$   
 $\beta_{mob} = N_{ref}/g_{eff}$   
 $g_{eff} \approx 1 \text{ cm}^{-1}$

# REVERSE CURRENT MODEL HIGH BIAS

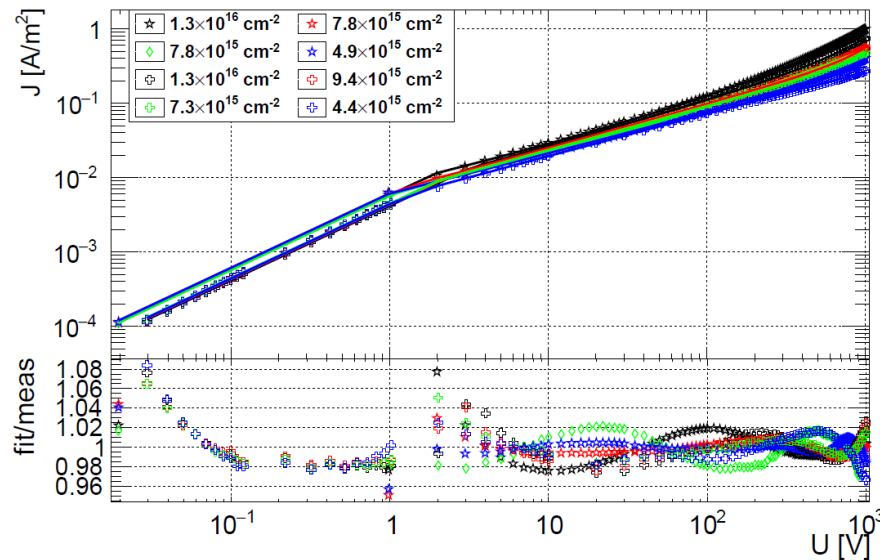


$$I = \frac{U}{R(U)} + I_{0,t} \cdot \left( \exp \left( \frac{U}{U_{0,t}} \right) - 1 \right)$$

$$R(U) = \begin{cases} \rho_{ohm}(\Phi_{eq}) \cdot \frac{d}{A} & U \leq U_{th} \\ \tilde{R}_{SCR}(\Phi_{eq}, A) \cdot U^{1-S(\Phi_{eq})} & U \geq U_{th} \end{cases}$$

- Current increases exponentially for high reverse bias
  - Empirical model describes the measurements within a few percent

# REVERSE CURRENT MODEL HIGH BIAS



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- Current increases exponentially for high reverse bias
  - Empirical model describes the measurements within a few percent
- Effects in the in high field of the SCR
  - Poole-Frenkel effect, trap-assisted tunneling, and/or impact ionization



# SUMMARY AND OUTLOOK



# SUMMARY AND OUTLOOK

## ■ Current model

$$I(U, A, d, \phi_{eq})$$

- Carrier removal
- Reverse: Threshold between ohmic and SCR-dominated current
  - Easy way to measure the mobility  $\mu(T, \phi_{eq})$
  - Replace  $U_{dep} + \alpha$  with  $\frac{U_{th}}{d^2}$  to determine  $\phi_{eq}$
- Reverse: Exponential increase at high voltages
- Forward: Space-charge-limited currents

# SUMMARY AND OUTLOOK

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## ■ To-do

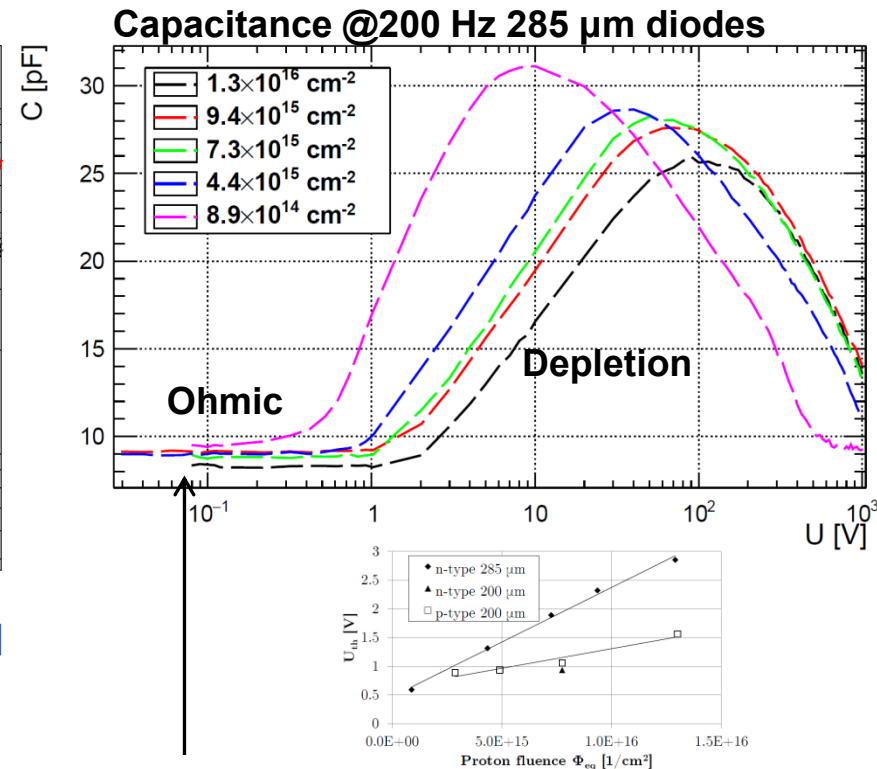
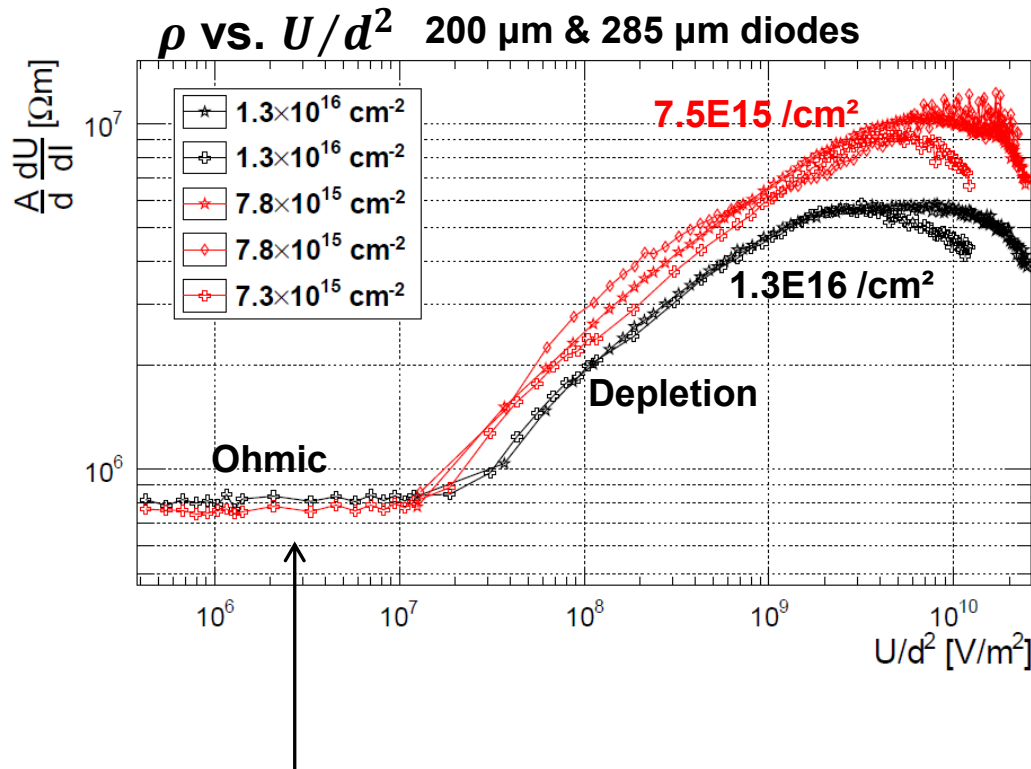
- Extract more physical quantities
- Temperature + annealing studies



# BACKUP

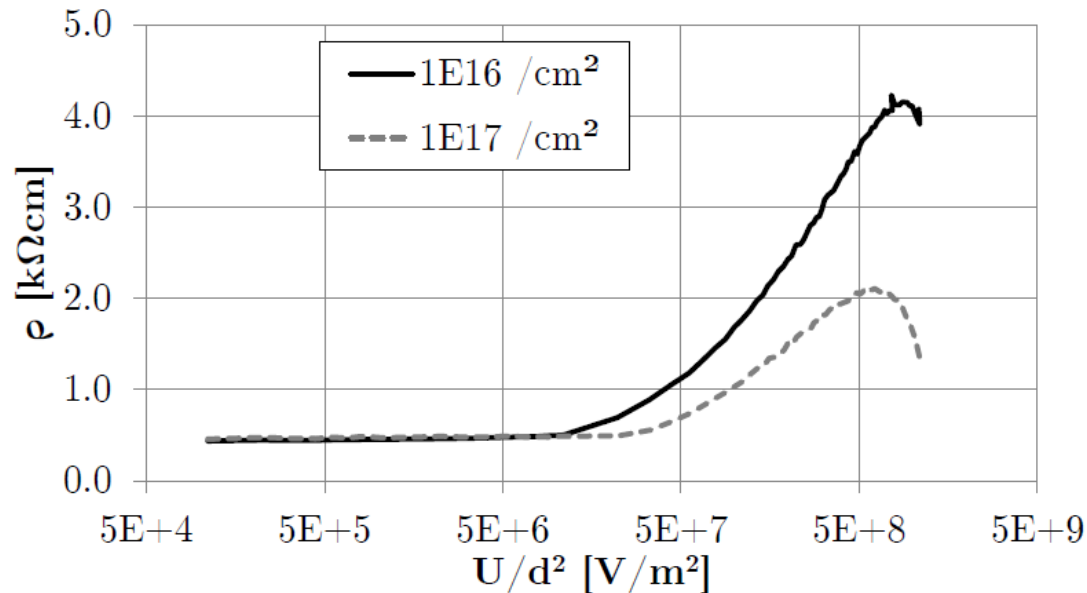
# CURRENT

## OHMIC REGION – NEUTRAL BULK



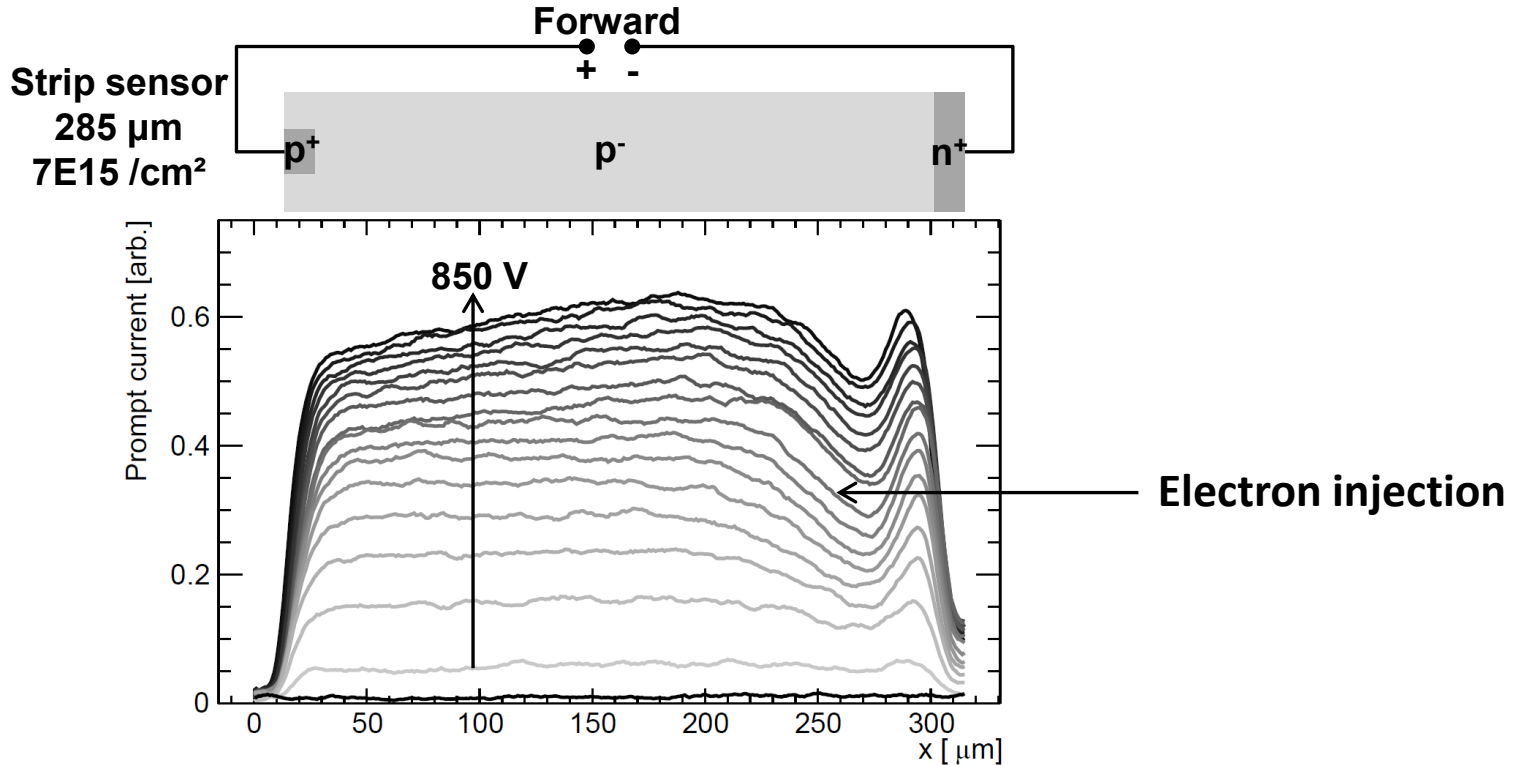
- High near-intrinsic  $\rho_{ohm} \approx \rho_i$  at small bias voltages
  - Carrier removal: Free carriers trapped at deep defects,  $n \approx p \approx n_i$

# BACKUP



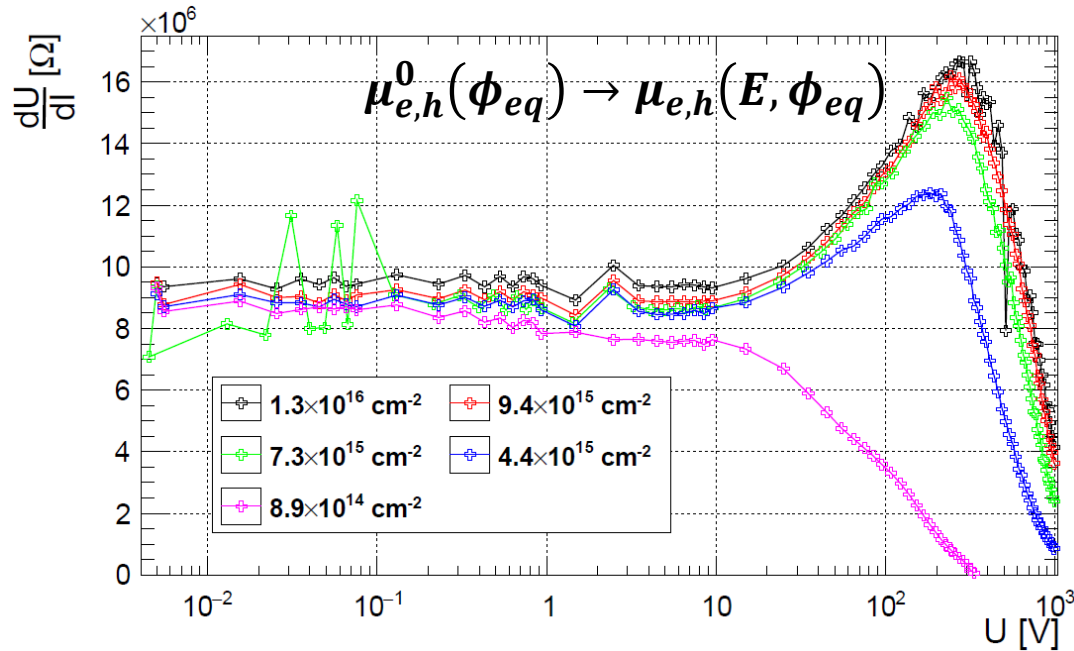
$\mu_0$  changes little up to  
 $\phi_{eq} = 10^{17} \text{ cm}^{-2}$  at 300 K  
 → Phonon scattering dominating at 300 K

# EDGE-TCT VELOCITY PROFILE FORWARD BIAS



- Edge-TCT  $v_e + v_h \propto E$  gives an idea of electric field
  - Electron injection from junction
  - Ohmic bulk at low voltage, positive space-charge at high voltage

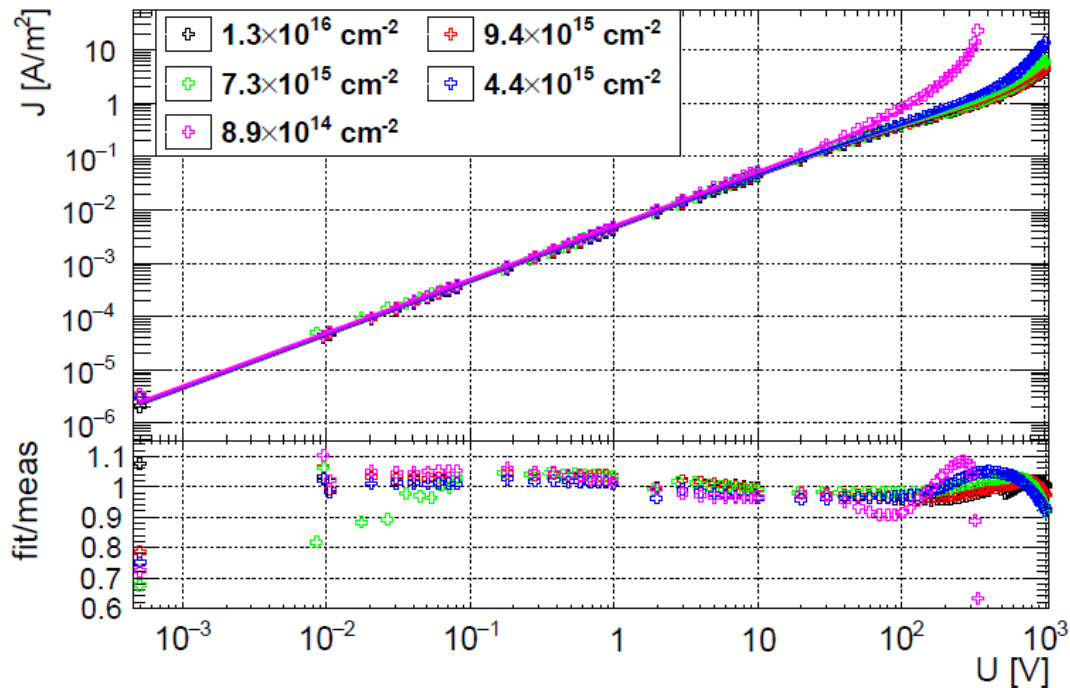
# FORWARD CURRENT RESISTANCE



Space-charge-limited currents  
**SCLC**

- Forward current described by space-charge-limited currents
  - Ohmic up to high voltages  $\mu_{e,h}^0(\phi_{eq}) \rightarrow \mu_{e,h}(E, \phi_{eq})$
  - Exponential increase at very high voltages

# FORWARD CURRENT MODEL



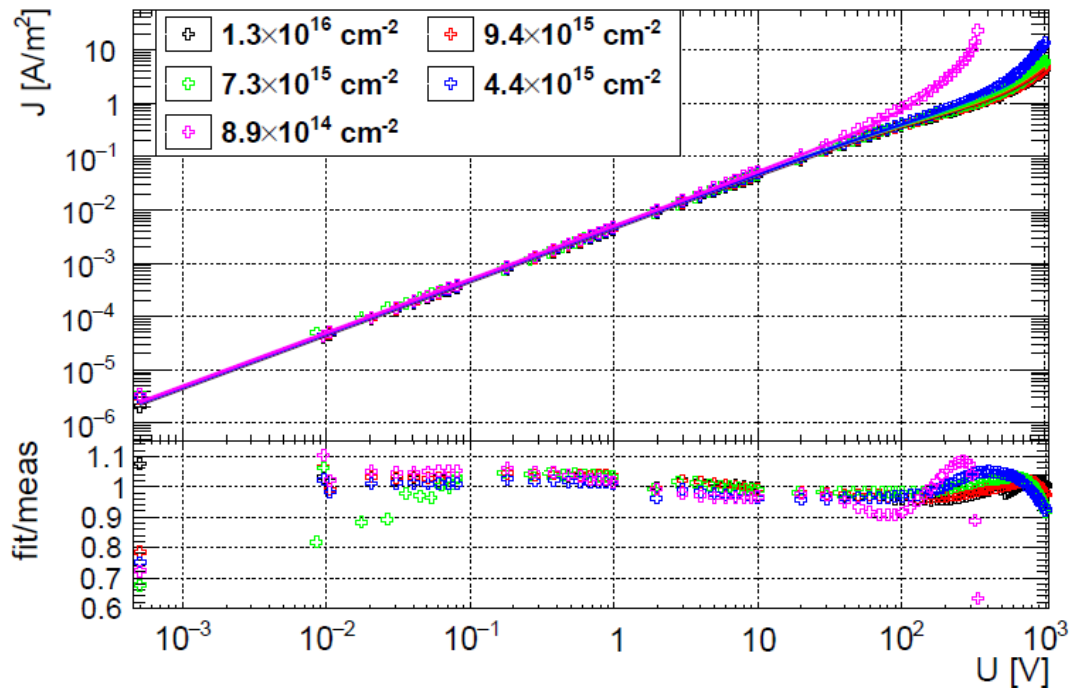
- Current described by SCLC within 10 %

$$I(U) = en_i \cdot A \frac{U}{d} \cdot \left( \mu_h(\Phi_{eq}, E) + \mu_e(\Phi_{eq}, E) \cdot \exp\left(\Xi \frac{U}{T \cdot d^2}\right) \right)$$

→ A. Rose. Phys. Rev. 97(6):1538, 1955.



# FORWARD CURRENT MODEL

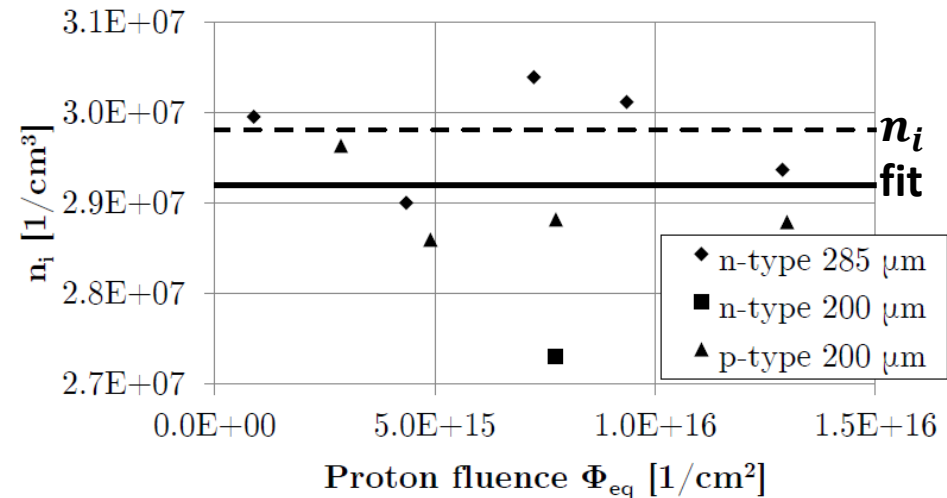
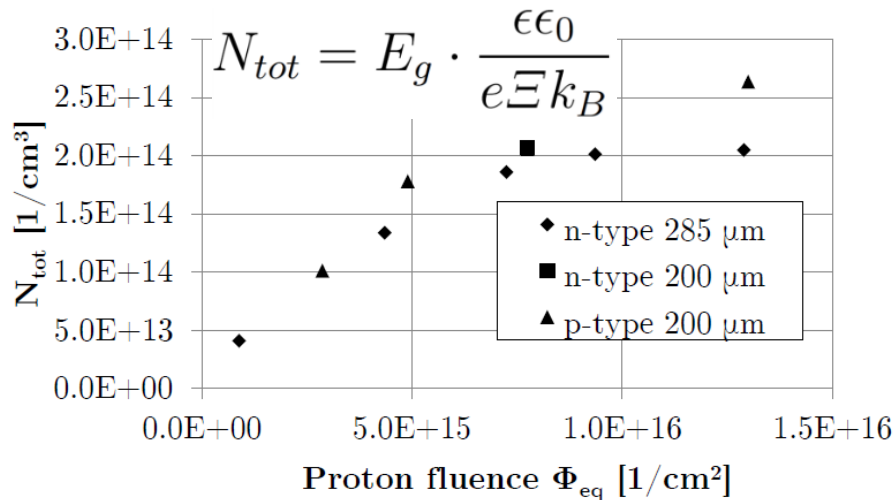


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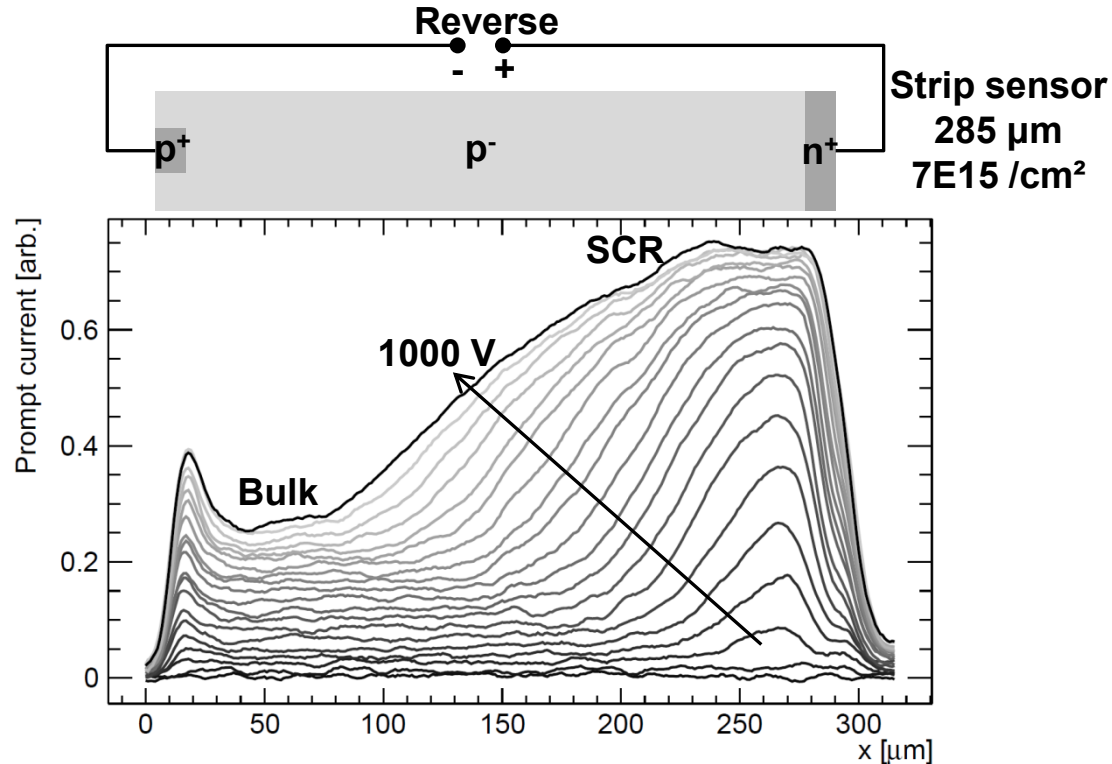
# FORWARD CURRENT MODEL PARAMETERS



$$I(U) = en_i \cdot A \frac{U}{d} \cdot \left( \mu_h(\Phi_{eq}, E) + \mu_e(\Phi_{eq}, E) \cdot \exp\left(\Xi \frac{U}{T \cdot d^2}\right) \right)$$

- Hypothetical trap concentration  $N_{tot}$  not linear with  $\Phi_{eq}$
- $n_i$  is reproduced to 2 %

# EDGE-TCT VELOCITY PROFILE REVERSE BIAS



- Edge-TCT  $v_e + v_h \propto E$  gives an idea of electric field
  - Near-constant field in the bulk
  - High field in the SCR

# BACKUP

